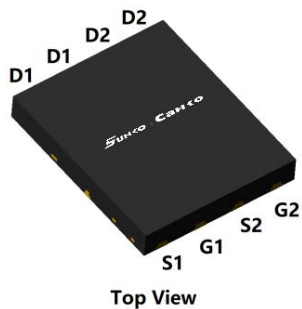
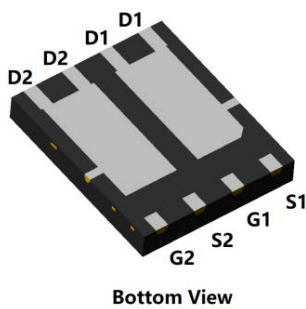


N-Channel and P-Channel Complementary MOSFET

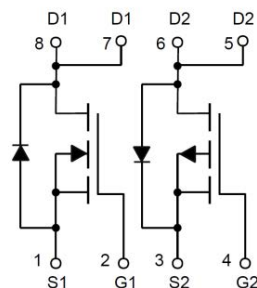


Top View



Bottom View

DFN5060-8L



Product Summary

NMOS

- V_{DS} 100V
- I_D 10A
- $R_{DS(ON)}$ (at $V_{GS}=10V$) $<110\text{ m}\Omega$
- $R_{DS(ON)}$ (at $V_{GS}=4.5V$) $<120\text{ m}\Omega$

PMOS

- V_{DS} -100V
- I_D -18A
- $R_{DS(ON)}$ (at $V_{GS}=-10V$) $<110\text{ m}\Omega$
- $R_{DS(ON)}$ (at $V_{GS}=-4.5V$) $<120\text{ m}\Omega$
- 100% EAS Tested

General Description

- Trench Power LV MOSFET technology
- Excellent package for heat dissipation
- Moisture Sensitivity Level 3
- Epoxy Meets UL 94 V-0 Flammability Rating
- Halogen Free

Applications

- Load switching
- Hard switched and high frequency circuits
- Uninterruptible power supply

■ Absolute Maximum Ratings ($T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter		Symbol	NMOS	PMOS	Unit
Drain-source Voltage		V_{DS}	100	-100	V
Gate-source Voltage		V_{GS}	± 20	± 20	V
Drain Current	$T_A=25^\circ\text{C}$	I_D	2.5	-3	A
	$T_A=100^\circ\text{C}$		1.6	-1.9	
	$T_C=25^\circ\text{C}$		10	-18	
	$T_C=100^\circ\text{C}$		6.3	-12	
Pulsed Drain Current ^A		I_{DM}	40	-72	A
Avalanche energy ^B		EAS	6.25	30.25	mJ
Total Power Dissipation ^C	$T_A=25^\circ\text{C}$	P_D	2	2.5	W
	$T_A=100^\circ\text{C}$		0.8	1	
	$T_C=25^\circ\text{C}$		30	72	
	$T_C=100^\circ\text{C}$		12.5	29	
Junction and Storage Temperature Range		T_J, T_{STG}	-55~+150	-55~+150	$^\circ\text{C}$

■ Thermal resistance

Parameter		Symbol	NMOS		PMOS		Units
			Typ	Max	Typ	Max	
Thermal Resistance Junction-to-Ambient ^D	Steady-State	$R_{\theta JA}$	50	60	40	50	$^\circ\text{C/W}$
Thermal Resistance Junction-to-Case	Steady-State	$R_{\theta JC}$	3.2	4	1.35	1.7	

■ Ordering Information (Example)

PREFERRED P/N	PACKING CODE	Marking	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
SCG10NP10A	F1	SCG10NP10A	5000	10000	100000	13" reel

SCG10NP10A

■ NMOS Electrical Characteristics (T_J=25℃ unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Static Parameter						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} = 0V, I _D =250μA	100	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =100V, V _{GS} =0V	-	-	1	μA
		V _{DS} =100V, V _{GS} =0V, T _J =150℃	-	-	100	
Gate-Body Leakage Current	I _{GSS}	V _{GS} = ±20V, V _{DS} =0V	-	-	±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D =250μA	1.1	1.8	3	V
Static Drain-Source On-Resistance	R _{DS(on)}	V _{GS} =10V, I _D =10A	-	90	110	mΩ
		V _{GS} =4.5V, I _D =5A	-	95	120	
Diode Forward Voltage	V _{SD}	I _S =10A, V _{GS} =0V	-	0.9	1.2	V
Gate resistance	R _G	f=1MHz, Open drain	-	1.6	-	Ω
Maximum Body-Diode Continuous Current	I _S		-	-	10	A
Dynamic Parameters						
Input Capacitance	C _{iSS}	V _{DS} =50V, V _{GS} =0V, f=1MHz	-	900	-	pF
Output Capacitance	C _{oss}		-	35	-	
Reverse Transfer Capacitance	C _{rss}		-	30	-	
Switching Parameters						
Total Gate Charge	Q _g	V _{GS} =10V, V _{DS} =50V, I _D =5A	-	16	-	nC
Gate-Source Charge	Q _{gs}		-	2.5	-	
Gate-Drain Charge	Q _{gd}		-	2.6	-	
Reverse Recovery Charge	Q _{rr}	I _F =5A, di/dt=350A/us	-	90	-	nC
Reverse Recovery Time	t _{rr}		-	35	-	ns
Turn-on Delay Time	t _{D(on)}	V _{GS} =10V, V _{DD} =50V, I _D =5A R _{GEN} =2.2Ω	-	5	-	ns
Turn-on Rise Time	t _r		-	40	-	
Turn-off Delay Time	t _{D(off)}		-	20	-	
Turn-off fall Time	t _f		-	7	-	

SCG10NP10A

■ PMOS Electrical Characteristics (T_J=25°C unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Static Parameter						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} = 0V, I _D =-250μA	-100	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-100V, V _{GS} =0V	-	-	-1	μA
		V _{DS} =-100V, V _{GS} =0V, T _j =150℃	-	-	-100	
Gate-Body Leakage Current	I _{GSS}	V _{GS} = ±20V, V _{DS} =0V	-	-	±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D =-250μA	-1	-1.8	-2.5	V
Static Drain-Source On-Resistance	R _{DS(on)}	V _{GS} =-10V, I _D =-10A	-	88	110	mΩ
		V _{GS} =-4.5V, I _D =-5A	-	95	120	
Diode Forward Voltage	V _{SD}	I _S =-10A, V _{GS} =0V	-	-0.9	-1.3	V
Gate resistance	R _G	f=1MHz, Open drain	-	10	-	Ω
Maximum Body-Diode Continuous Current	I _S		-	-	-18	A
Dynamic Parameters						
Input Capacitance	C _{iss}	V _{DS} =-50V, V _{GS} =0V, f=1MHz	-	1050	-	pF
Output Capacitance	C _{oss}		-	120	-	
Reverse Transfer Capacitance	C _{rss}		-	25	-	
Switching Parameters						
Total Gate Charge	Q _g	V _{GS} =-10V, V _{DS} =-50V, I _D =-5A	-	20	-	nC
Gate-Source Charge	Q _{gs}		-	4	-	
Gate-Drain Charge	Q _{gd}		-	4.5	-	
Reverse Recovery Charge	Q _{rr}	I _F =-5A, di/dt=100A/us	-	140	-	nC
Reverse Recovery Time	t _{rr}		-	70	-	ns
Turn-on Delay Time	t _{D(on)}	V _{GS} =-10V, V _{DD} =-50V, R _L =2.5Ω R _{GEN} =6Ω	-	10	-	ns
Turn-on Rise Time	t _r		-	30	-	
Turn-off Delay Time	t _{D(off)}		-	77	-	
Turn-off fall Time	t _f		-	81	-	

A. Repetitive rating; pulse width limited by max. junction temperature.

B. NMOS: T_J=25°C, V_{DD}=50V, V_G=10V, R_G=25Ω, L=0.5mH, I_{AS}=5A.

PMOS: T_J=25°C, V_{DD}=-50V, V_G=-10V, R_G=25Ω, L=0.5mH, I_{AS}=-11A.

C. P_d is based on max. junction temperature, using junction-case thermal resistance.

D. The value of R_{θJA} is measured with the device mounted on the minimum recommend pad size, in the still air environment with T_A =25°C. The maximum allowed junction temperature of 150°C. The value in any given application depends on the user's specific board design.

■ NMOS Typical Electrical and Thermal Characteristics Diagrams

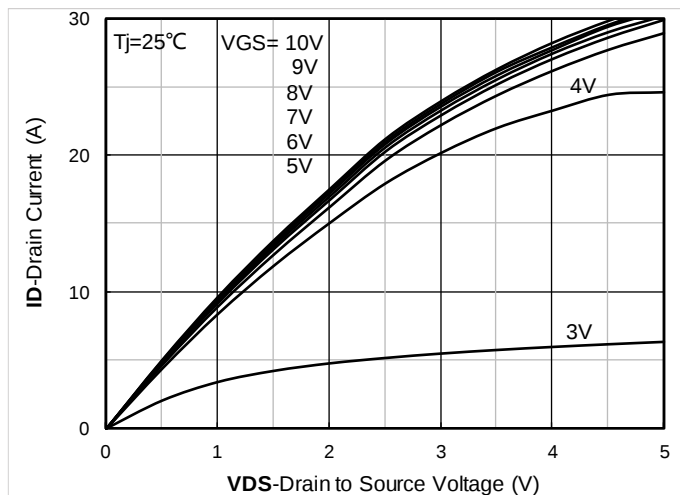


Figure1. Output Characteristics

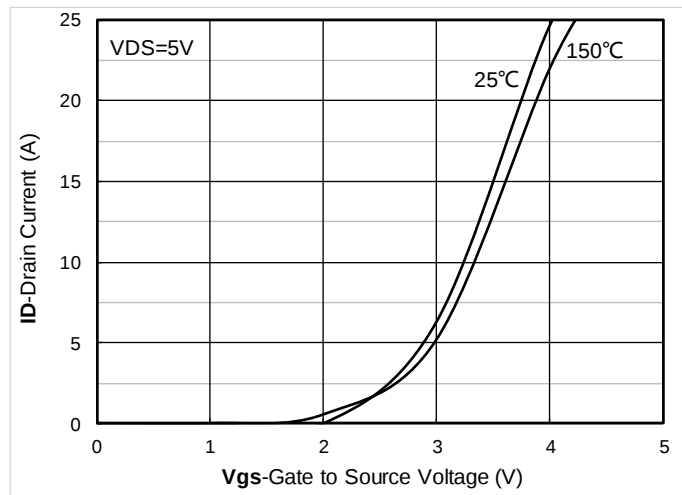


Figure2. Transfer Characteristics

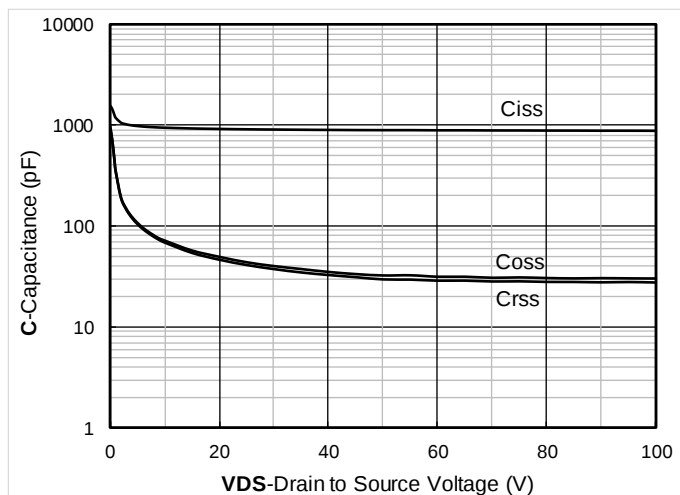


Figure3. Capacitance Characteristics

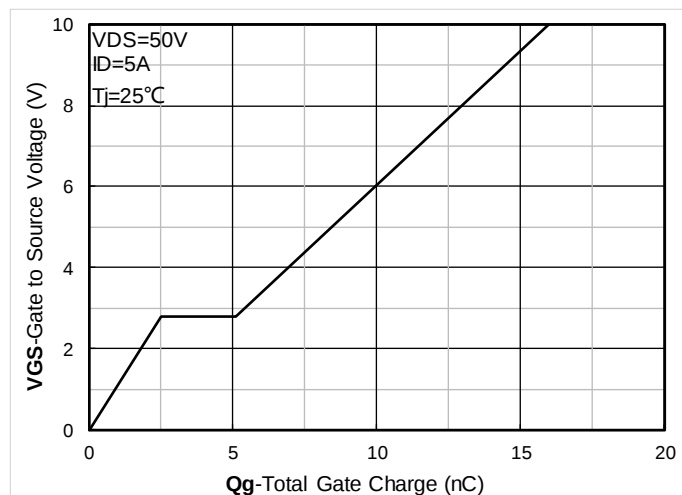


Figure4. Gate Charge

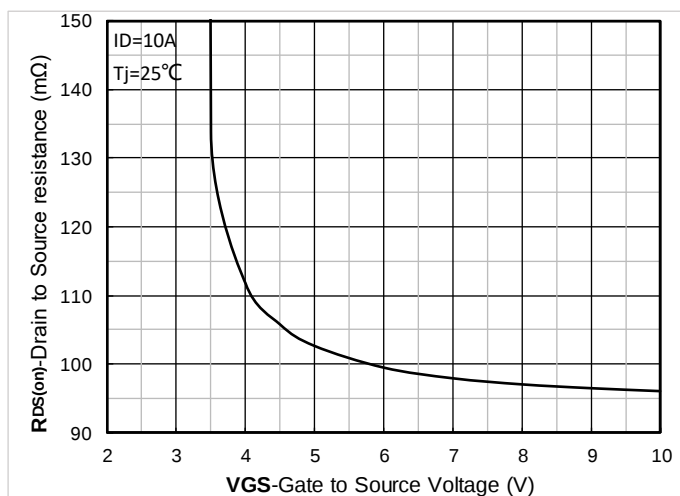


Figure5. On-Resistance vs Gate to Source Voltage

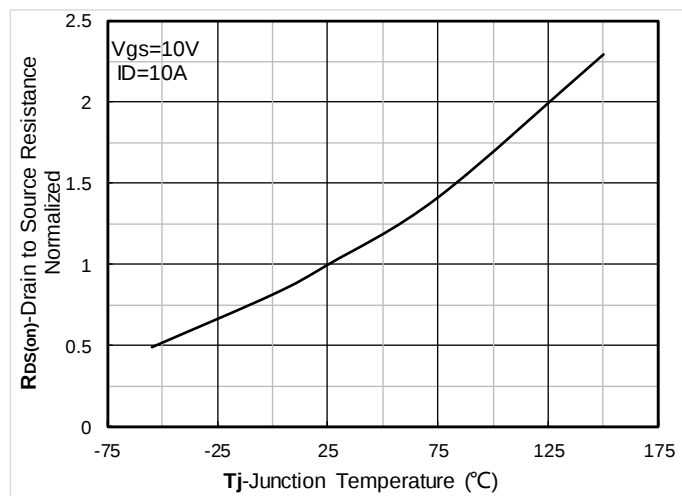


Figure6. Normalized On-Resistan

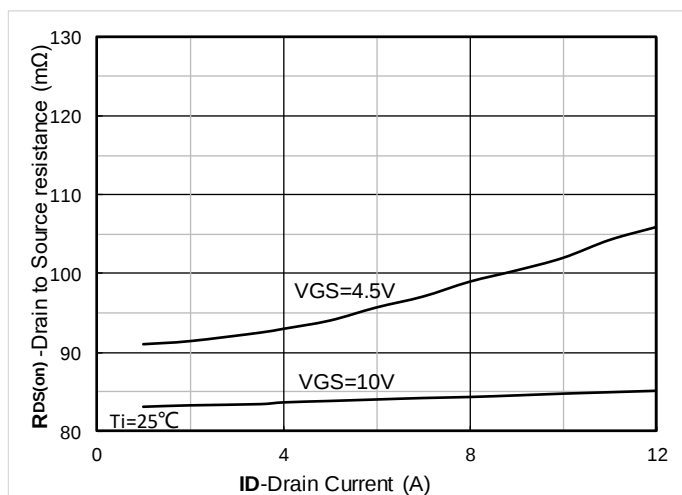


Figure7. $R_{DS(on)}$ VS Drain Current

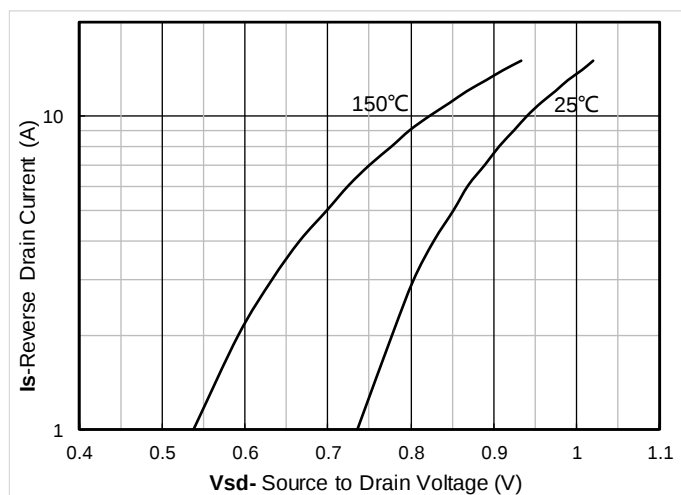


Figure8. Forward characteristics of reverse diode

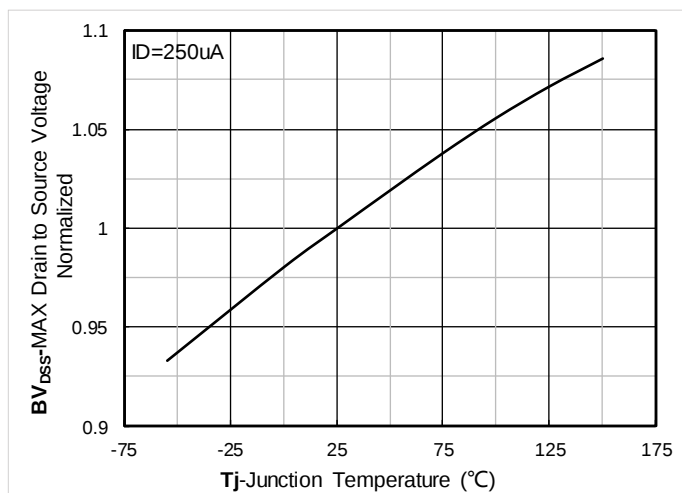


Figure9. Normalized breakdown voltage

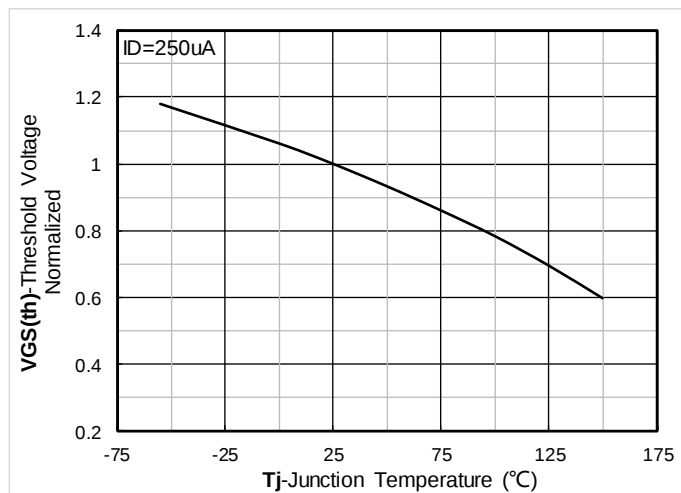


Figure10. Normalized Threshold voltage

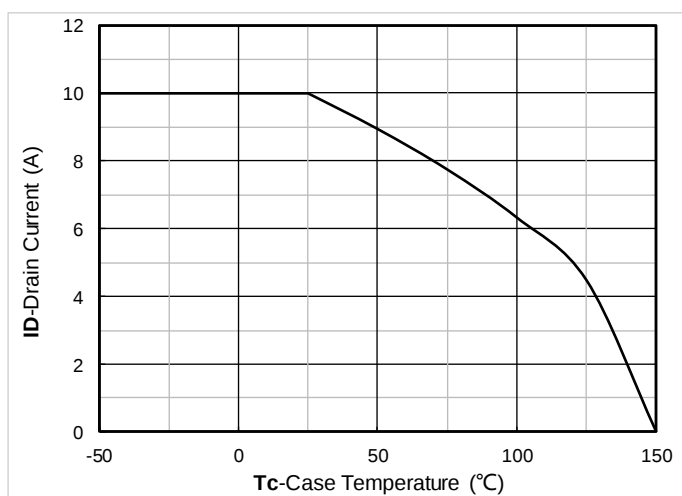


Figure11. Current dissipation

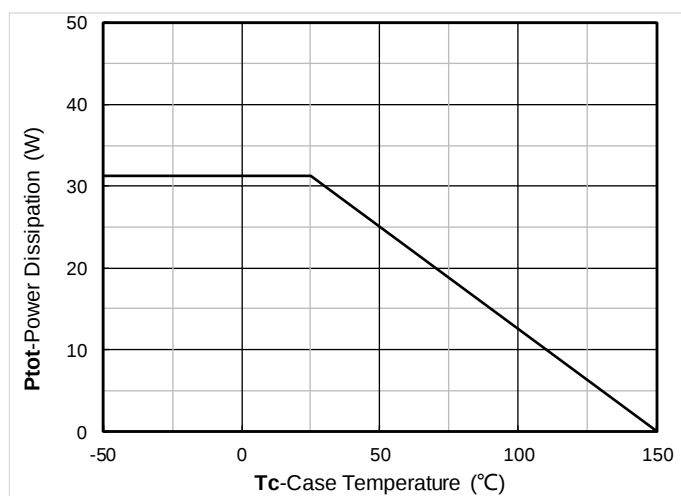


Figure12. Power dissipation

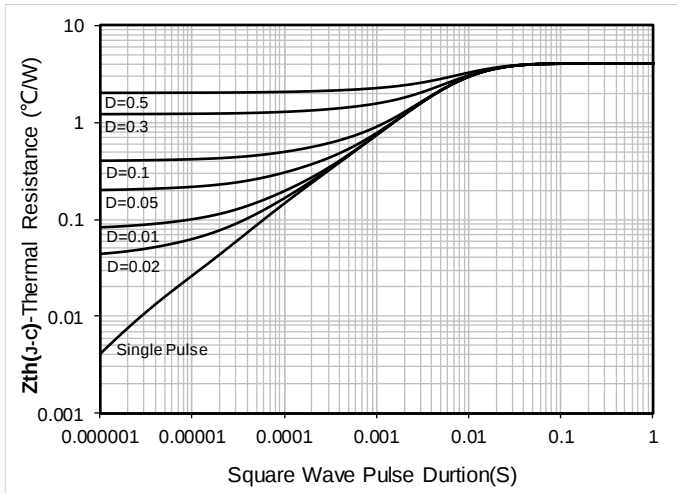


Figure13. Maximum Transient Thermal Impedance

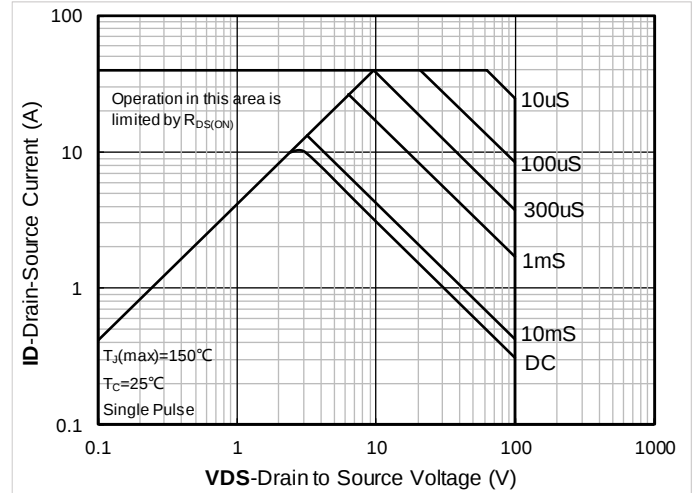


Figure14. Safe Operation Area

PMOS Typical Electrical and Thermal Characteristics Diagrams

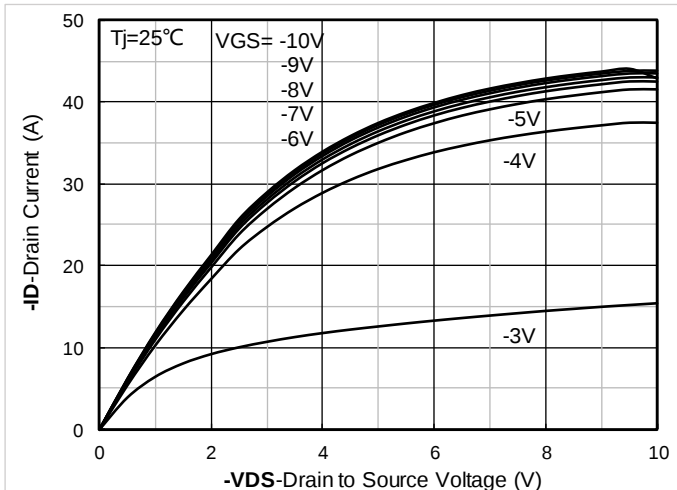


Figure1. Output Characteristics

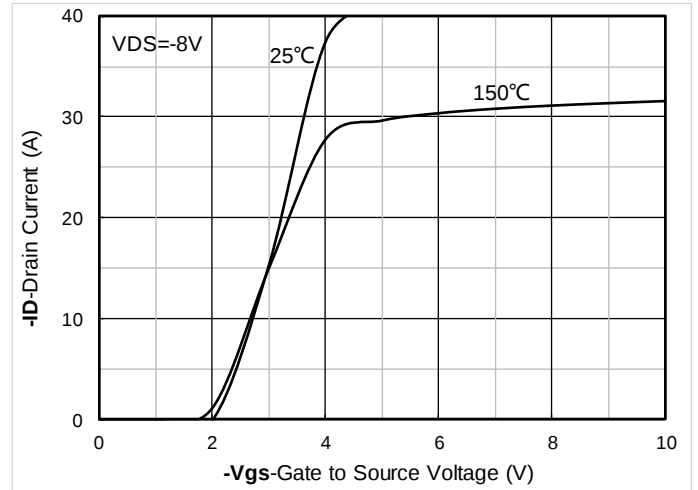


Figure2. Transfer Characteristics

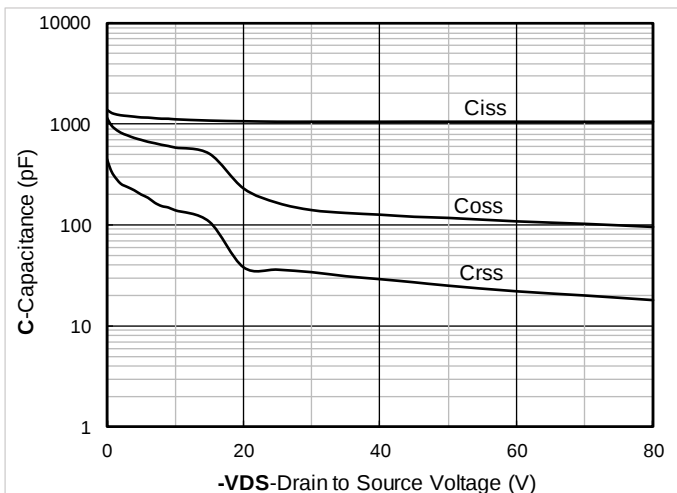


Figure3. Capacitance Characteristics

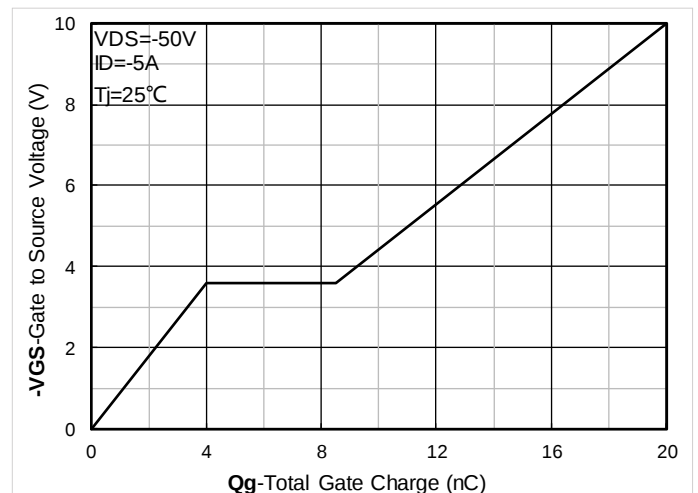


Figure4. Gate Charge

SCG10NP10A

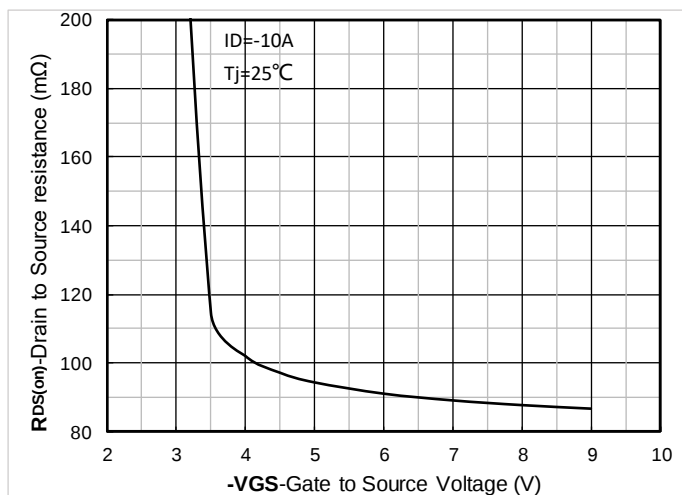


Figure5. On-Resistance vs Gate to Source Voltage

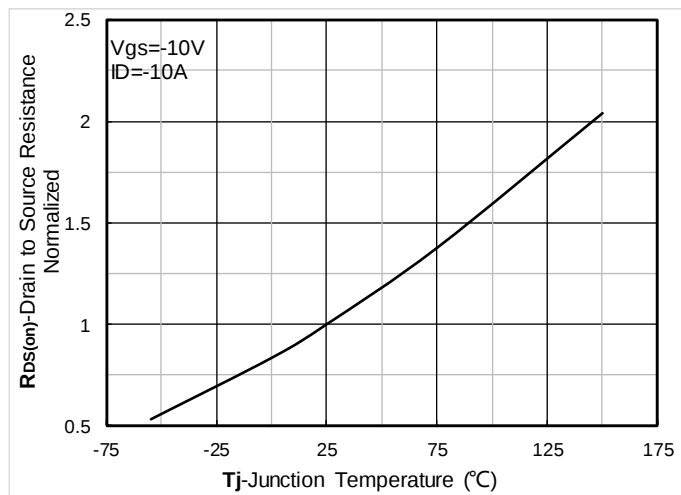


Figure6. Normalized On-Resistance

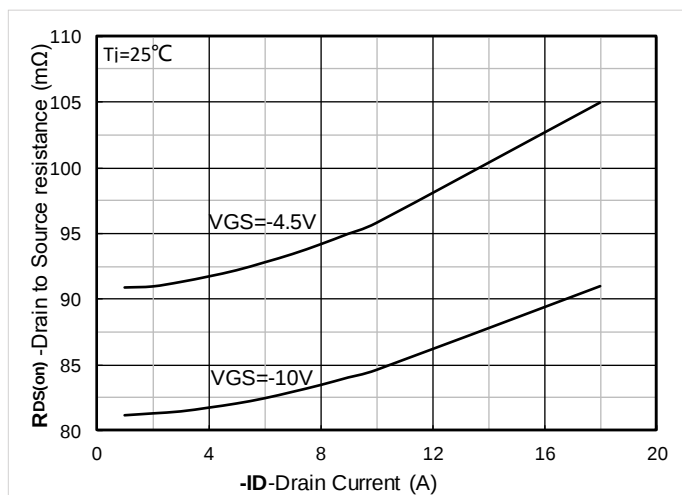


Figure7. RDS(on) VS Drain Current

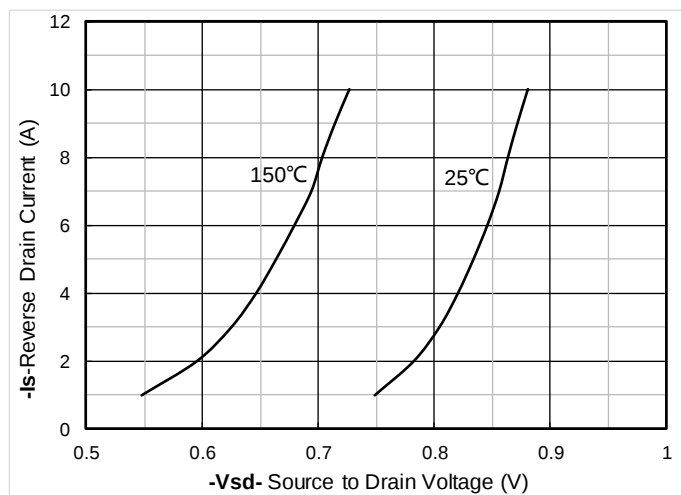


Figure8. Forward characteristics of reverse diode

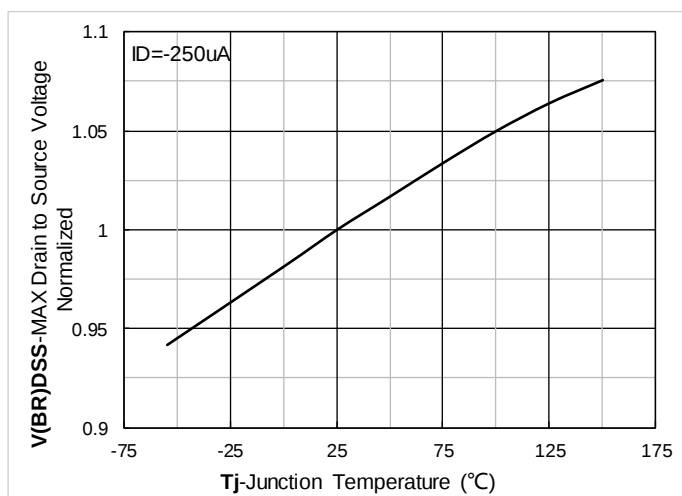


Figure9. Normalized breakdown voltage

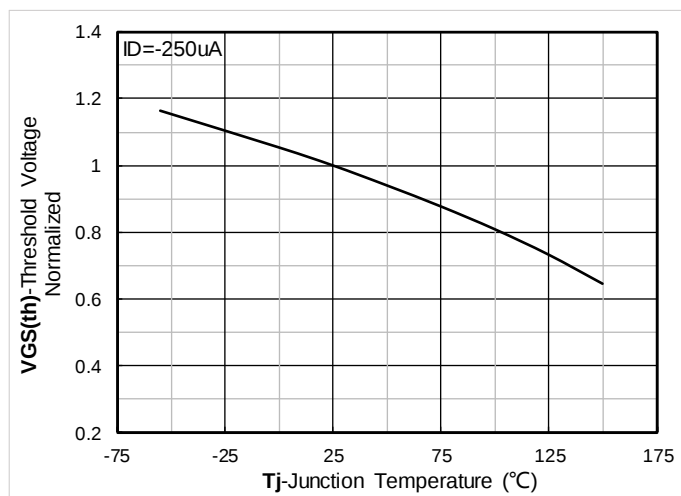


Figure10. Normalized Threshold voltage

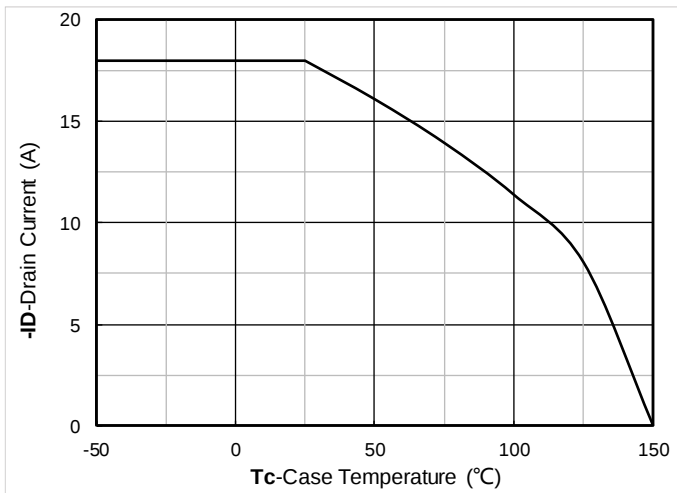


Figure11. Current dissipation

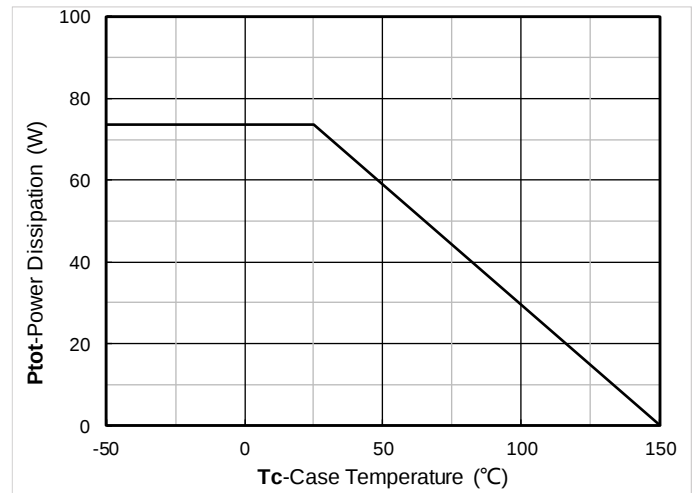


Figure12. Power dissipation

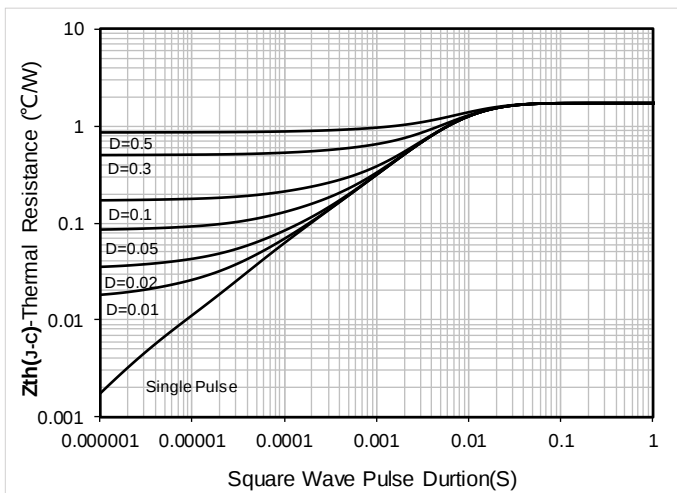


Figure13. Maximum Transient Thermal Impedance

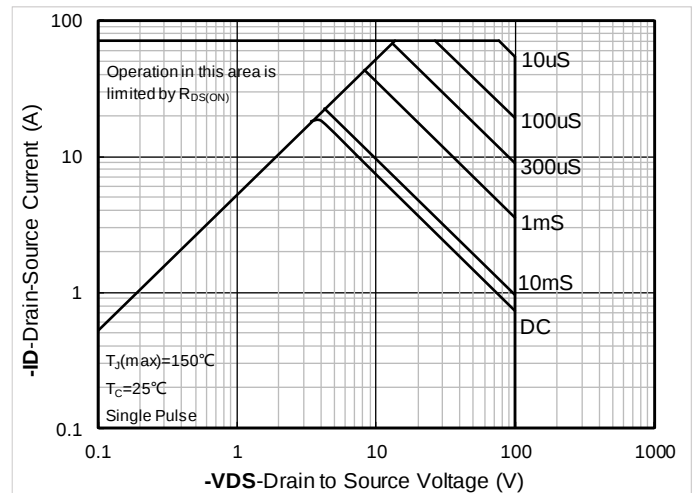
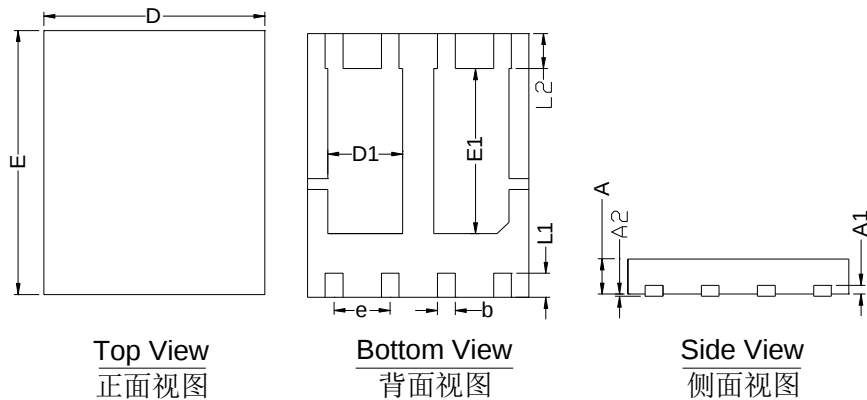


Figure14. Safe Operation Area

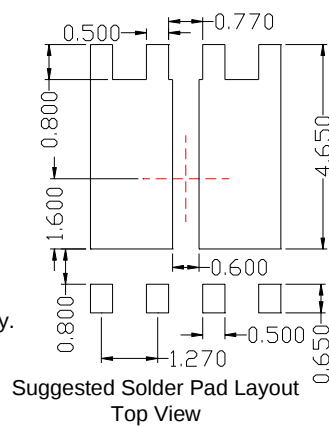
■ DFN5060-8L Package Information



SYMBOL	MILLIMETER		
	MIN	NOM	MAX
D	4.90	5.00	5.10
E	5.90	6.00	6.10
A	0.70	0.80	0.90
A1	0.20 BSC		
A2			0.10
D1	1.60	1.70	1.80
E1	3.65	3.75	3.85
L1	0.45	0.55	0.65
L2	0.80 BSC		
b	0.30	0.40	0.50
e	1.27 BSC		

Note:

1. Controlling dimension: in millimeters.
2. General tolerance: $\pm 0.10\text{mm}$.
3. The pad layout is for reference purposes only.



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